Semiconductors:



Electroplating & Integrated Circuit Production

NEW FOR 2025-2026!

Quality check was performed to ensure web links still work and equipment lists are up to date.

PLANNING FOR THE CHALLENGE:

SUGGESTED LESSON PLAN - 50 minute periods

Total Time ~100-120 minutes

- ~35 minutes to watch the lab introduction video (MAIN Lab portion)
- ~10 minutes to review safety precautions
- ~40-50 minutes for students to design, build and test their prototype
- ~ 5-15 minutes to record answers and observations in Student Workbook or Abbreviated Worksheet
- ~10 minutes for a closing activity or discussion

(Note: An optional 30-45 minutes can be scheduled to do a Wrap-Up and QA with an Engineer and College Mentor at

Teacher's discretion).			
Hook/Essential Question	How are semiconductors the "brains" of all modern electronics?		
Supplies to Have in Class	ET Semiconductors Kit materials can be found at the end of this file. • Gloves • Safety Goggles • Copper Wire • AA Battery w/ holder • Jumper Cables • Alcohol cleaning pad • Substrate (Nickel or metal disk) • 3 oz plastic cup		

Additional Items to Consider Having on Hand:

- Water
- Paper towels
- Tape

NOTE: Some sites referred to in the workbook may be blocked by school internet protocols. Please request admin access for the sites **below** in advance so that you students will have access before they begin working through the student workbook/worksheet

https://docs.google.com/document/d/1LSyc1l2uAuWM7sv3h7puUra3b pDn_j4rPlIIhWA4RBc/edit?usp=drive_link

The videos **below** should be unblocked for **teachers-only** if presenting the student workbook to the whole class OR for all students if they are completing the student workbook on their school devices Main Workbook

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	<u> </u>		
	https://www.youtube.com/watch?v=c9arR8T0Qts		
Optional Pre-Work	Have students watch the first 19 min of the introvideo providing the background for the challenge and answer the questions on through slide 29 (just before Part 4 Your Semiconductor Challenge) of the student workbook.		
Class #1 Introduction and Procedure	 Watch the Engineering Tomorrow: Semiconductors Intro Recording on the Semiconductors webpage either as a class or assign background section as pre-work (see above). → Have students answer the comprehension questions in the first 29 slides of the student workbook → Watch the rest of the video that outlines the instructions for the challenge. Student teams begin to design their semiconductor experiment → research designs, review materials, generate an initial design concept and describe in their Workbook or Abbreviated Worksheet. (1 workbook or worksheet per team is suggested) 		
Class #2 Work Time and Testing	 → Students design their semiconductor experiment → research designs, review materials, generate an initial design concept and describe in their Student Workbook or Abbreviated Worksheet. (Slides 30-49) ◆ Prepare the Bath (Copper II Sulfate) and Object to be Plated and cleaning coin / substrate with alcohol wipes ◆ Prepare the Circuit and Start Plating ◆ Allow time for plating ◆ Wipe off any masking and wash your hands 		
Part of Class #3 Possible Closing Questions and Activities	 Class Discussion Questions: The semiconductor industry implements highly precise processes to create microchips. How could you reduce errors in this experiment? What other industries do you think could implement semiconductors? What would happen if there was a semiconductor shortage? Who would be affected? (This did happen in 2020) For students who have taken chemistry: what type of reaction is occurring here between the copper sulfate and the substrate? 		

INTRODUCTION TO ENGINEERING TOMORROW:

• Click <u>here</u> to see an introduction of what Engineering Tomorrow can do for your students.

INTRODUCTION TO THE ENGINEERING DESIGN PROCESS:

• Students should complete the Engineering Design Process Introduction Activity before starting the lab

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 NOTE: This activity only needs to be completed before the student's <u>first</u> ET lab, not repeated for every lab.

SAFETY PROCEDURES:

 Safety procedures for this lab may be found in <u>this document</u>. This includes proper attire and disposal of the solution.

TEACHER NOTES:

- Students will work through the **Semiconductors** <u>Student Workbook</u> or the <u>Abbreviated Student Worksheet</u>.
 - When assigning this lesson on Google Classroom, <u>first make a copy</u> of the slides to save within your Google Drive, <u>then assign so that each student has their own copy</u>.
 - The workbook and worksheet are designed to be interactive so that students can type directly into the files. It is suggested that the workbook or worksheet be completed over a few class periods (as the information is delivered to students).
 - Students may work individually or within groups (at the discretion of the instructor).

ASSESSMENT:

- Informal assessments can be completed by looking at the reflection slides within the Student Workbook and/or the discussion questions in the Abbreviated Worksheet.
- **Answer Keys** can be found here for the:
 - Student Workbook Answer Key
 - Abbreviated Worksheet Answer Key

TROUBLESHOOTING TIPS:

- Make sure the copper piece and the nickel are not touching
- Make sure the copper and nickel are at least 3 cm apart from each other to prevent a short circuit
- Make sure the nickel is clean before plating by wiping it with an alcohol wipe. Plating may not stick if the nickel is not clean

PRE AND POST WORK IDEAS:

- <u>Pre-work Assignment</u> students watch 4 min video which introduces the semiconductor manufacturing process and goes inside the world's largest semiconductor factory
- <u>Post Work Assignment</u> students watch part of all of the "Chip In" documentaries, which highlight three young professionals as they explore the semiconductor industry.

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EXTENSION ACTIVITIES:

- Research how other processes work in semiconductor production
- Discuss the economics of semiconductors, and read this article to learn more
- Watch this <u>video</u> to learn more about semiconductor manufacturing.

ADDITIONAL TEACHING RESOURCES: **Curriculum Connections:** Students will be able to -Chemical Engineering: using math, science, and Analyze real-world problems and use critical engineering concepts to produce solutions thinking skills in order to solve them using chemical processes • Work through and understand the • Materials Science: creating specific and engineering design process complex materials using scientific processes. • Use an electroplating technique commonly found in semiconductor production • <u>Electrical Engineering:</u> designing systems which use electricity, electromagnetism, and • Understand the growth and impact of the semiconductor industry electronics • Mechanical Engineering: creating machinery to make specific products and perform tasks • Computer Science: developing software systems to control modern technology

Content Vocabulary/Terms:

- <u>Integrated circuit:</u> small electronic circuits on a piece of semiconductor material. They contain electronic "brains" that are programmed for various tasks, including storing and managing data.
- Semiconductor: a material with conductivity that lies between that of an insulator and a conductor.
- <u>Transistor:</u> a 3 terminal device made of semiconductor material. They have many uses, including amplification, switching, voltage regulation, and the modulation of signals.
- <u>Moore's Law:</u> an observation that the number of transistors on a microchip roughly doubles every two years.
- <u>Photolithography:</u> A fabrication process that transfer a pattern from a photomask to a silicon substrate wafer
- <u>Etching:</u> A process that removes layers or slices of a material, such as semiconductors, metals, dielectrics, and polymers
- <u>Metal Deposition:</u> A process where thin metallic film coating is carefully deposited onto a substrate to yield specific material properties

NEXT GENERATION SCIENCE STANDARDS:

<u>HS-ETS1-1</u>. Analyze a major global challenge to specify qualitative and quantitative criteria and constraints for solutions that account for societal needs and wants.

<u>HS-ETS1-2</u>. Design a solution to a complex real-world problem by breaking it down into smaller, more manageable problems that can be solved through engineering.

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MATERIALS:

TEACHER'S KIT				
Materials will be distributed throughout the class				
Item/Link	Quantity	Photo		
<u>Goggles</u>	30			

CLASSROOM EXTRAS				
Item/Link	Distribution	Photo		
<u>Scissors</u>	1 for Every 10 Students			

STUDENT KIT ITEMS				
1 kit: 3 students				
Item/Link	Quantity	Photo		
Plastic Cup (3 oz.)	1			
Gloves	6			
<u>Alcohol Pads</u>	6	ALCOHOL PREP PAR ME CONTROL PREP PAR ME P		
<u>Jumper Wires</u>	2			
Metal substrates (can also use a coin)	3	OR S		





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<u>Copper Wire</u>	1	
Permanent Marker	1	Sharpie,
Single Battery Holder	1	HAAA
AA Battery	1	DURACELL